ETHERNET POWER 3.84W MAX

BUILD ON PMP8407 REV C PCB

34 TO 57VDC AUX INPUT

Additional EMI filtering may be required.

More details and components are shown in the diagram, including resistors, capacitors, and other electronic components.
(All in LOT5571)
L2
NA6069-AL

F = 250kHz
APD Start = 36V
Delay = 40nsec

(Short L1 if not used)
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